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### What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

### Applications of "[Embedded - Microcontrollers](#)"

#### Details

Product Status	Active
Core Processor	ARM® Cortex®-M0
Core Size	32-Bit Single-Core
Speed	50MHz
Connectivity	I <sup>2</sup> C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, WDT
Number of I/O	16
Program Memory Size	4KB (4K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 5x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	20-SOIC (0.295", 7.50mm Width)
Supplier Device Package	20-SO
Purchase URL	<a href="https://www.e-xfl.com/product-detail/nxp-semiconductors/lpc1110fd20-529">https://www.e-xfl.com/product-detail/nxp-semiconductors/lpc1110fd20-529</a>

Table 1. Ordering information ...continued

Type number	Package		
	Name	Description	Version
LPC1115JBD48/303	LQFP48	LQFP48: plastic low profile quad flat package; 48 leads; body 7 × 7 × 1.4 mm	SOT313-2
LPC1115FET48/303	TFBGA48	plastic thin fine-pitch ball grid array package; 48 balls; body 4.5 × 4.5 × 0.7 mm	SOT1155-2
LPC1115JET48/303	TFBGA48	plastic thin fine-pitch ball grid array package; 48 balls; body 4.5 × 4.5 × 0.7 mm	SOT1155-2

## 4.1 Ordering options

Table 2. Ordering options

Type number	Series	Flash	Total SRAM	Power profiles	UART	I <sup>2</sup> C/ Fast+	SPI	ADC channel	GPIO	Package	Temp <sup>[1]</sup>
<b>LPC1110</b>											
LPC1110FD20	LPC1100L	4 kB	1 kB	yes	1	1	1	5	16	SO20	F
<b>LPC1111</b>											
LPC1111FDH20/002	LPC1100L	8 kB	2 kB	yes	1	1	1	5	16	TSSOP20	F
LPC1111FHN33/101	LPC1100	8 kB	2 kB	no	1	1	1	8	28	HVQFN33	F
LPC1111FHN33/102	LPC1100L	8 kB	2 kB	yes	1	1	1	8	28	HVQFN33	F
LPC1111FHN33/103	LPC1100XL	8 kB	2 kB	yes	1	1	2	8	28	HVQFN33	F
LPC1111JHN33/103	LPC1100XL	8 kB	2 kB	yes	1	1	2	8	28	HVQFN33	J
LPC1111FHN33/201	LPC1100	8 kB	4 kB	no	1	1	1	8	28	HVQFN33	F
LPC1111FHN33/202	LPC1100L	8 kB	4 kB	yes	1	1	1	8	28	HVQFN33	F
LPC1111FHN33/203	LPC1100XL	8 kB	4 kB	yes	1	1	2	8	28	HVQFN33	F
LPC1111JHN33/203	LPC1100XL	8 kB	4 kB	yes	1	1	2	8	28	HVQFN33	J
<b>LPC1112</b>											
LPC1112FD20/102	LPC1100L	16 kB	4 kB	yes	1	1	1	5	16	SO20	F
LPC1112FDH20/102	LPC1100L	16 kB	4 kB	yes	1	-	1	5	14	TSSOP20	F
LPC1112FDH28/102	LPC1100L	16 kB	4 kB	yes	1	1	1	6	22	TSSOP28	F
LPC1112FHN24/202	LPC1100L	16 kB	4 kB	yes	1	1	1	6	19	HVQFN24	F
LPC1112FHN33/101	LPC1100	16 kB	2 kB	no	1	1	1	8	28	HVQFN33	F
LPC1112FHN33/102	LPC1100L	16 kB	2 kB	yes	1	1	1	8	28	HVQFN33	F
LPC1112FHN33/103	LPC1100XL	16 kB	2 kB	yes	1	1	2	8	28	HVQFN33	F
LPC1112JHN33/103	LPC1100XL	16 kB	2 kB	yes	1	1	2	8	28	HVQFN33	J
LPC1112FHN33/201	LPC1100	16 kB	4 kB	no	1	1	1	8	28	HVQFN33	F
LPC1112FHN33/202	LPC1100L	16 kB	4 kB	yes	1	1	1	8	28	HVQFN33	F
LPC1112FHN33/203	LPC1100XL	16 kB	4 kB	yes	1	1	2	8	28	HVQFN33	F
LPC1112JHN33/203	LPC1100XL	16 kB	4 kB	yes	1	1	2	8	28	HVQFN33	J
LPC1112FHI33/102	LPC1100L	16 kB	2 kB	yes	1	1	1	8	28	HVQFN33	F
LPC1112FHI33/202	LPC1100L	16 kB	4 kB	yes	1	1	1	8	28	HVQFN33	F
LPC1112FHI33/203	LPC1100XL	16 kB	4 kB	yes	1	1	2	8	28	HVQFN33	F
LPC1112JHI33/203	LPC1100XL	16 kB	4 kB	yes	1	1	2	8	28	HVQFN33	J

**Table 4.** LPC1100L series: LPC1110/11/12 pin description table (SO20 and TSSOP20 package with I<sup>2</sup>C-bus pins) ...continued

Symbol	Pin SO20/ TSSOP20	Start logic input	Type	Reset state [1]	Description
R/PIO0_11/ AD0/CT32B0_MAT3	4 [5]	yes	I	I; PU	<b>R</b> — Reserved. Configure for an alternate function in the IOCONFIG block.
			I/O	-	<b>PIO0_11</b> — General purpose digital input/output pin.
			I	-	<b>AD0</b> — A/D converter, input 0.
			O	-	<b>CT32B0_MAT3</b> — Match output 3 for 32-bit timer 0.
PIO1_0 to PIO1_7			I/O		<b>Port 1</b> — Port 1 is a 12-bit I/O port with individual direction and function controls for each bit. The operation of port 1 pins depends on the function selected through the IOCONFIG register block.
R/PIO1_0/ AD1/CT32B1_CAP0	7 [5]	yes	I	I; PU	<b>R</b> — Reserved. Configure for an alternate function in the IOCONFIG block.
			I/O	-	<b>PIO1_0</b> — General purpose digital input/output pin.
			I	-	<b>AD1</b> — A/D converter, input 1.
			I	-	<b>CT32B1_CAP0</b> — Capture input 0 for 32-bit timer 1.
R/PIO1_1/ AD2/CT32B1_MAT0	8 [5]	no	O	I; PU	<b>R</b> — Reserved. Configure for an alternate function in the IOCONFIG block.
			I/O	-	<b>PIO1_1</b> — General purpose digital input/output pin.
			I	-	<b>AD2</b> — A/D converter, input 2.
			O	-	<b>CT32B1_MAT0</b> — Match output 0 for 32-bit timer 1.
R/PIO1_2/ AD3/CT32B1_MAT1	9 [5]	no	I	I; PU	<b>R</b> — Reserved. Configure for an alternate function in the IOCONFIG block.
			I/O	-	<b>PIO1_2</b> — General purpose digital input/output pin.
			I	-	<b>AD3</b> — A/D converter, input 3.
			O	-	<b>CT32B1_MAT1</b> — Match output 1 for 32-bit timer 1.
SWDIO/PIO1_3/ AD4/CT32B1_MAT2	10 [5]	no	I/O	I; PU	<b>SWDIO</b> — Serial wire debug input/output.
			I/O	-	<b>PIO1_3</b> — General purpose digital input/output pin.
			I	-	<b>AD4</b> — A/D converter, input 4.
			O	-	<b>CT32B1_MAT2</b> — Match output 2 for 32-bit timer 1.
PIO1_6/RXD/ CT32B0_MAT0	11 [3]	no	I/O	I; PU	<b>PIO1_6</b> — General purpose digital input/output pin.
			I	-	<b>RXD</b> — Receiver input for UART.
			O	-	<b>CT32B0_MAT0</b> — Match output 0 for 32-bit timer 0.
PIO1_7/TXD/ CT32B0_MAT1	12 [3]	no	I/O	I; PU	<b>PIO1_7</b> — General purpose digital input/output pin.
			O	-	<b>TXD</b> — Transmitter output for UART.
			O	-	<b>CT32B0_MAT1</b> — Match output 1 for 32-bit timer 0.
V <sub>DD</sub>	15	-		-	3.3 V supply voltage to the internal regulator, the external rail, and the ADC. Also used as the ADC reference voltage.
XTALIN	14 [6]	-	I	-	Input to the oscillator circuit and internal clock generator circuits. Input voltage must not exceed 1.8 V.
XTALOUT	13 [6]	-	O	-	Output from the oscillator amplifier.
V <sub>SS</sub>	16	-		-	Ground.

- [1] Pin state at reset for default function: I = Input; O = Output; PU = internal pull-up enabled (pins pulled up to full  $V_{DD}$  level); IA = inactive, no pull-up/down enabled.
- [2] 5 V tolerant pad.  $\overline{\text{RESET}}$  functionality is not available in Deep power-down mode.
- [3] 5 V tolerant pad providing digital I/O functions with configurable pull-up/pull-down resistors and configurable hysteresis (see [Figure 51](#)).
- [4] I<sup>2</sup>C-bus pin compliant with the I<sup>2</sup>C-bus specification for I<sup>2</sup>C standard mode and I<sup>2</sup>C Fast-mode Plus. The pin requires an external pull-up to provide output functionality. When power is switched off, this pin is floating and does not disturb the I<sup>2</sup>C lines. Open-drain configuration applies to all functions on this pin.
- [5] 5 V tolerant pad providing digital I/O functions with configurable pull-up/pull-down resistors, configurable hysteresis, and analog input. When configured as a ADC input, digital section of the pad is disabled and the pin is not 5 V tolerant (see [Figure 51](#)).
- [6] When the system oscillator is not used, connect XTALIN and XTALOUT as follows: XTALIN can be left floating or can be grounded (grounding is preferred to reduce susceptibility to noise). XTALOUT should be left floating.

**Table 5. LPC1100L series: LPC1112 pin description table (TSSOP20 with  $V_{DDA}$  and  $V_{SSA}$  pins)**

Symbol	Pin TSSOP20	Start logic input	Type	Reset state [1]	Description
PIO0_0 to PIO0_11			I/O		<b>Port 0</b> — Port 0 is a 12-bit I/O port with individual direction and function controls for each bit. The operation of port 0 pins depends on the function selected through the IOCONFIG register block.
$\overline{\text{RESET}}$ /PIO0_0	17 [2]	yes	I	I; PU	<b>RESET</b> — External reset input with 20 ns glitch filter. A LOW-going pulse as short as 50 ns on this pin resets the device, causing I/O ports and peripherals to take on their default states, and processor execution to begin at address 0. In deep power-down mode, this pin must be pulled HIGH externally. The $\overline{\text{RESET}}$ pin can be left unconnected or be used as a GPIO pin if an external $\overline{\text{RESET}}$ function is not needed and Deep power-down mode is not used.
			I/O	-	<b>PIO0_0</b> — General purpose digital input/output pin with 10 ns glitch filter.
PIO0_1/CLKOUT/CT32B0_MAT2	18 [3]	yes	I/O	I; PU	<b>PIO0_1</b> — General purpose digital input/output pin. A LOW level on this pin during reset starts the ISP command handler.
			O	-	<b>CLKOUT</b> — Clockout pin.
			O	-	<b>CT32B0_MAT2</b> — Match output 2 for 32-bit timer 0.
PIO0_2/SSEL0/CT16B0_CAP0	19 [3]	yes	I/O	I; PU	<b>PIO0_2</b> — General purpose digital input/output pin.
			I/O	-	<b>SSEL0</b> — Slave Select for SPI0.
			I	-	<b>CT16B0_CAP0</b> — Capture input 0 for 16-bit timer 0.
PIO0_3	20 [3]	yes	I/O	I; PU	<b>PIO0_3</b> — General purpose digital input/output pin.
PIO0_8/MISO0/CT16B0_MAT0	1 [3]	yes	I/O	I; PU	<b>PIO0_8</b> — General purpose digital input/output pin.
			I/O	-	<b>MISO0</b> — Master In Slave Out for SPI0.
			O	-	<b>CT16B0_MAT0</b> — Match output 0 for 16-bit timer 0.
PIO0_9/MOSI0/CT16B0_MAT1	2 [3]	yes	I/O	I; PU	<b>PIO0_9</b> — General purpose digital input/output pin.
			I/O	-	<b>MOSI0</b> — Master Out Slave In for SPI0.
			O	-	<b>CT16B0_MAT1</b> — Match output 1 for 16-bit timer 0.

Table 6. LPC1100L series: LPC1112 (HVQFN24 package) ...continued

Symbol	HVQFN pin	Start logic input	Type	Reset state [1]	Description
SWDIO/PIO1_3/ AD4/CT32B1_MAT2	19 <sup>[5]</sup>	no	I/O	I; PU	<b>SWDIO</b> — Serial wire debug input/output.
			I/O	-	<b>PIO1_3</b> — General purpose digital input/output pin.
			I	-	<b>AD4</b> — A/D converter, input 4.
			O	-	<b>CT32B1_MAT2</b> — Match output 2 for 32-bit timer 1.
PIO1_4/AD5/ CT32B1_MAT3/ WAKEUP	20 <sup>[5]</sup>	no	I/O	I; PU	<b>PIO1_4</b> — General purpose digital input/output pin with 10 ns glitch filter. In Deep power-down mode, this pin serves as the Deep power-down mode wake-up pin with 20 ns glitch filter. Pull this pin HIGH externally before entering Deep power-down mode. Pull this pin LOW to exit Deep power-down mode. A LOW-going pulse as short as 50 ns wakes up the part.
			I	-	<b>AD5</b> — A/D converter, input 5.
			O	-	<b>CT32B1_MAT3</b> — Match output 3 for 32-bit timer 1.
PIO1_6/RXD/ CT32B0_MAT0	23 <sup>[3]</sup>	no	I/O	I; PU	<b>PIO1_6</b> — General purpose digital input/output pin.
			I	-	<b>RXD</b> — Receiver input for UART.
			O	-	<b>CT32B0_MAT0</b> — Match output 0 for 32-bit timer 0.
PIO1_7/TXD/ CT32B0_MAT1	24 <sup>[3]</sup>	no	I/O	I; PU	<b>PIO1_7</b> — General purpose digital input/output pin.
			O	-	<b>TXD</b> — Transmitter output for UART.
			O	-	<b>CT32B0_MAT1</b> — Match output 1 for 32-bit timer 0.
PIO1_8/ CT16B1_CAP0	6 <sup>[3]</sup>	no	I/O	I; PU	<b>PIO1_8</b> — General purpose digital input/output pin.
			I	-	<b>CT16B1_CAP0</b> — Capture input 0 for 16-bit timer 1.
XTALIN	4 <sup>[6]</sup>	-	I	-	Input to the oscillator circuit and internal clock generator circuits. Input voltage must not exceed 1.8 V.
V <sub>DD</sub>	5; 22	-	I	-	1.8 V supply voltage to the internal regulator, the external rail, and the ADC. Also used as the ADC reference voltage.
V <sub>SS</sub>	3; 21	-	I	-	Ground.

- [1] Pin state at reset for default function: I = Input; O = Output; PU = internal pull-up enabled (pins pulled up to full V<sub>DD</sub> level); IA = inactive, no pull-up/down enabled.
- [2] 5 V tolerant pad. **RESET** functionality is not available in Deep power-down mode. Use the WAKEUP pin to reset the chip and wake up from Deep power-down mode. An external pull-up resistor is required on this pin for the Deep power-down mode. See [Figure 52](#) for the reset pad configuration.
- [3] Pad providing digital I/O functions with configurable pull-up/pull-down resistors and configurable hysteresis (see [Figure 51](#)).
- [4] I<sup>2</sup>C-bus pads compliant with the I<sup>2</sup>C-bus specification for I<sup>2</sup>C standard mode and I<sup>2</sup>C Fast-mode Plus. The pin requires an external pull-up to provide output functionality. When power is switched off, this pin is floating and does not disturb the I<sup>2</sup>C lines. Open-drain configuration applies to all functions on this pin.
- [5] Pad providing digital I/O functions with configurable pull-up/pull-down resistors, configurable hysteresis, and analog input. When configured as a ADC input, digital section of the pad is disabled (see [Figure 51](#)).
- [6] When the system oscillator is not used, connect XTALIN and XTALOUT as follows: XTALIN can be left floating or can be grounded (grounding is preferred to reduce susceptibility to noise). XTALOUT should be left floating.

Table 9. LPC1100 and LPC1100L series: LPC1111/12/13/14 pin description table (HVQFN33 package) ...continued

Symbol	Pin	Start logic input	Type	Reset state [1]	Description
PIO1_7/TXD/ CT32B0_MAT1	32 <sup>[3]</sup>	no	I/O	I;PU	<b>PIO1_7</b> — General purpose digital input/output pin.
			O	-	<b>TXD</b> — Transmitter output for UART.
			O	-	<b>CT32B0_MAT1</b> — Match output 1 for 32-bit timer 0.
PIO1_8/ CT16B1_CAP0	7 <sup>[3]</sup>	no	I/O	I;PU	<b>PIO1_8</b> — General purpose digital input/output pin.
			I	-	<b>CT16B1_CAP0</b> — Capture input 0 for 16-bit timer 1.
PIO1_9/ CT16B1_MAT0	12 <sup>[3]</sup>	no	I/O	I;PU	<b>PIO1_9</b> — General purpose digital input/output pin.
			O	-	<b>CT16B1_MAT0</b> — Match output 0 for 16-bit timer 1.
PIO1_10/AD6/ CT16B1_MAT1	20 <sup>[5]</sup>	no	I/O	I;PU	<b>PIO1_10</b> — General purpose digital input/output pin.
			I	-	<b>AD6</b> — A/D converter, input 6.
			O	-	<b>CT16B1_MAT1</b> — Match output 1 for 16-bit timer 1.
PIO1_11/AD7	27 <sup>[5]</sup>	no	I/O	I;PU	<b>PIO1_11</b> — General purpose digital input/output pin.
			I	-	<b>AD7</b> — A/D converter, input 7.
PIO2_0					<b>Port 2</b> — Port 2 is a 12-bit I/O port with individual direction and function controls for each bit. The operation of port 2 pins depends on the function selected through the IOCONFIG register block. Pins PIO2_1 to PIO2_11 are not available.
PIO2_0/DTR	1 <sup>[3]</sup>	no	I/O	I;PU	<b>PIO2_0</b> — General purpose digital input/output pin.
			O	-	<b>DTR</b> — Data Terminal Ready output for UART.
PIO3_0 to PIO3_5					<b>Port 3</b> — Port 3 is a 12-bit I/O port with individual direction and function controls for each bit. The operation of port 3 pins depends on the function selected through the IOCONFIG register block. Pins PIO3_0, PIO3_1, PIO3_3 and PIO3_6 to PIO3_11 are not available.
PIO3_2	28 <sup>[3]</sup>	no	I/O	I;PU	<b>PIO3_2</b> — General purpose digital input/output pin.
PIO3_4	13 <sup>[3]</sup>	no	I/O	I;PU	<b>PIO3_4</b> — General purpose digital input/output pin.
PIO3_5	14 <sup>[3]</sup>	no	I/O	I;PU	<b>PIO3_5</b> — General purpose digital input/output pin.
V <sub>DD</sub>	6; 29	-	I	-	3.3 V supply voltage to the internal regulator, the external rail, and the ADC. Also used as the ADC reference voltage.
XTALIN	4 <sup>[6]</sup>	-	I	-	Input to the oscillator circuit and internal clock generator circuits. Input voltage must not exceed 1.8 V.
XTALOUT	5 <sup>[6]</sup>	-	O	-	Output from the oscillator amplifier.
V <sub>SS</sub>	33	-	-	-	Thermal pad. Connect to ground.

- [1] Pin state at reset for default function: I = Input; O = Output; PU = internal pull-up enabled (pins pulled up to 2.6 V for LPC111x/101/201/301, pins pulled up to full V<sub>DD</sub> level on LPC111x/002/102/202/302 (V<sub>DD</sub> = 3.3 V)); IA = inactive, no pull-up/down enabled.
- [2] 5 V tolerant pad. **RESET** functionality is not available in Deep power-down mode. Use the WAKEUP pin to reset the chip and wake up from Deep power-down mode. An external pull-up resistor is required on this pin for the Deep power-down mode. See [Figure 52](#) for the reset pad configuration.
- [3] 5 V tolerant pad providing digital I/O functions with configurable pull-up/pull-down resistors and configurable hysteresis (see [Figure 51](#)).
- [4] I<sup>2</sup>C-bus pads compliant with the I<sup>2</sup>C-bus specification for I<sup>2</sup>C standard mode and I<sup>2</sup>C Fast-mode Plus. The pin requires an external pull-up to provide output functionality. When power is switched off, this pin is floating and does not disturb the I2C lines. Open-drain configuration applies to all functions on this pin.
- [5] 5 V tolerant pad providing digital I/O functions with configurable pull-up/pull-down resistors, configurable hysteresis, and analog input. When configured as a ADC input, digital section of the pad is disabled, and the pin is not 5 V tolerant (see [Figure 51](#)).

## 7. Functional description

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### 7.1 ARM Cortex-M0 processor

The ARM Cortex-M0 is a general purpose, 32-bit microprocessor, which offers high performance and very low power consumption.

### 7.2 On-chip flash program memory

The LPC1110/11/12/13/14/15 contain 64 kB (LPC1115), 56 kB (LPC1114/333), 48 kB (LPC1114/323), 32 kB (LPC1114), 24 kB (LPC1113), 16 kB (LPC1112), 8 kB (LPC1111) or 4 kB (LPC1110) of on-chip flash memory.

### 7.3 On-chip SRAM

The LPC1110/11/12/13/14/15 contain a total of 8 kB, 4 kB, 2 kB, or 1 kB on-chip static RAM memory.

### 7.4 Memory map

The LPC1110/11/12/13/14/15 incorporate several distinct memory regions, shown in the following figures. [Figure 14](#) shows the overall map of the entire address space from the user program viewpoint following reset. The interrupt vector area supports address remapping.

The AHB peripheral area is 2 MB in size, and is divided to allow for up to 128 peripherals. The APB peripheral area is 512 kB in size and is divided to allow for up to 32 peripherals. Each peripheral of either type is allocated 16 kB of space. This allows simplifying the address decoding for each peripheral.

- In the LPC1110/11/12/13/14/15, the NVIC supports 32 vectored interrupts including up to 13 inputs to the start logic from individual GPIO pins.
- Four programmable interrupt priority levels with hardware priority level masking.
- Software interrupt generation.

### 7.5.2 Interrupt sources

Each peripheral device has one interrupt line connected to the NVIC but may have several interrupt flags. Individual interrupt flags may also represent more than one interrupt source.

Any GPIO pin (total of up to 42 pins) regardless of the selected function, can be programmed to generate an interrupt on a level, or rising edge or falling edge, or both.

### 7.6 IOCONFIG block

The IOCONFIG block allows selected pins of the microcontroller to have more than one function. Configuration registers control the multiplexers to allow connection between the pin and the on-chip peripherals.

Peripherals should be connected to the appropriate pins prior to being activated and prior to any related interrupt(s) being enabled. Activity of any enabled peripheral function that is not mapped to a related pin should be considered undefined.

### 7.7 Fast general purpose parallel I/O

Device pins that are not connected to a specific peripheral function are controlled by the GPIO registers. Pins may be dynamically configured as inputs or outputs. Multiple outputs can be set or cleared in one write operation.

LPC1110/11/12/13/14/15 use accelerated GPIO functions:

- GPIO registers are a dedicated AHB peripheral so that the fastest possible I/O timing can be achieved.
- Entire port value can be written in one instruction.

Additionally, any GPIO pin (total of up to 42 pins) providing a digital function can be programmed to generate an interrupt on a level, a rising or falling edge, or both.

#### 7.7.1 Features

- Bit level port registers allow a single instruction to set or clear any number of bits in one write operation.
- Direction control of individual bits.
- All I/O default to inputs with pull-ups enabled after reset with the exception of the I<sup>2</sup>C-bus pins PIO0\_4 and PIO0\_5.
- Pull-up/pull-down resistor configuration can be programmed through the IOCONFIG block for each GPIO pin (except for pins PIO0\_4 and PIO0\_5).
- On the LPC1100, all GPIO pins (except PIO0\_4 and PIO0\_5) are pulled up to 2.6 V ( $V_{DD} = 3.3$  V) if their pull-up resistor is enabled in the IOCONFIG block.



- On the LPC1100L and LPC1100XL series, all GPIO pins (except PIO0\_4 and PIO0\_5) are pulled up to 3.3 V ( $V_{DD} = 3.3$  V) if their pull-up resistor is enabled in the IOCONFIG block.
- Programmable open-drain mode for series LPC1100L and LPC1100XL.

## 7.8 UART

The LPC1110/11/12/13/14/15 contain one UART.

Support for RS-485/9-bit mode allows both software address detection and automatic address detection using 9-bit mode.

The UART includes a fractional baud rate generator. Standard baud rates such as 115200 Bd can be achieved with any crystal frequency above 2 MHz.

### 7.8.1 Features

- Maximum UART data bit rate of 3.125 MBit/s.
- 16 Byte Receive and Transmit FIFOs.
- Register locations conform to 16C550 industry standard.
- Receiver FIFO trigger points at 1 B, 4 B, 8 B, and 14 B.
- Built-in fractional baud rate generator covering wide range of baud rates without a need for external crystals of particular values.
- FIFO control mechanism that enables software flow control implementation.
- Support for RS-485/9-bit mode.
- Support for modem control.

## 7.9 SPI serial I/O controller

The LPC1100 and LPC1100L series contain two SPI controllers on the LQFP48 package and one SPI controller on the HVQFN33/TSSOP28/DIP28/TSSOP20/SO20 packages (SPI0).

The LPC1100XL series contain two SPI controllers.

Both SPI controllers support SSP features.

The SPI controller is capable of operation on a SSP, 4-wire SSI, or Microwire bus. It can interact with multiple masters and slaves on the bus. Only a single master and a single slave can communicate on the bus during a given data transfer. The SPI supports full duplex transfers, with frames of 4 bits to 16 bits of data flowing from the master to the slave and from the slave to the master. In practice, often only one of these data flows carries meaningful data.

### 7.9.1 Features

- Maximum SPI speed of 25 Mbit/s (master) or 4.17 Mbit/s (slave) (in SSP mode)
- Compatible with Motorola SPI, 4-wire Texas Instruments SSI, and National Semiconductor Microwire buses
- Synchronous serial communication

- Master or slave operation
- 8-frame FIFOs for both transmit and receive
- 4-bit to 16-bit frame

## 7.10 I<sup>2</sup>C-bus serial I/O controller

The LPC1110/11/12/13/14/15 contain one I<sup>2</sup>C-bus controller.

**Remark:** Part LPC1112FDH20/102 does not contain the I<sup>2</sup>C-bus controller.

The I<sup>2</sup>C-bus is bidirectional for inter-IC control using only two wires: a Serial Clock Line (SCL) and a Serial Data line (SDA). Each device is recognized by a unique address and can operate as either a receiver-only device (e.g., an LCD driver) or a transmitter with the capability to both receive and send information (such as memory). Transmitters and/or receivers can operate in either master or slave mode, depending on whether the chip has to initiate a data transfer or is only addressed. The I<sup>2</sup>C is a multi-master bus and can be controlled by more than one bus master connected to it.

### 7.10.1 Features

- The I<sup>2</sup>C-interface is a standard I<sup>2</sup>C-bus compliant interface with open-drain pins. The I<sup>2</sup>C-bus interface also supports Fast-mode Plus with bit rates up to 1 Mbit/s.
- Easy to configure as master, slave, or master/slave.
- Programmable clocks allow versatile rate control.
- Bidirectional data transfer between masters and slaves.
- Multi-master bus (no central master).
- Arbitration between simultaneously transmitting masters without corruption of serial data on the bus.
- Serial clock synchronization allows devices with different bit rates to communicate via one serial bus.
- Serial clock synchronization can be used as a handshake mechanism to suspend and resume serial transfer.
- The I<sup>2</sup>C-bus can be used for test and diagnostic purposes.
- The I<sup>2</sup>C-bus controller supports multiple address recognition and a bus monitor mode.

## 7.11 10-bit ADC

The LPC1110/11/12/13/14/15 contain one ADC. It is a single 10-bit successive approximation ADC with eight channels.

### 7.11.1 Features

- 10-bit successive approximation ADC.
- Input multiplexing among 8 pins.
- Power-down mode.
- Measurement range 0 V to V<sub>DD</sub>.
- 10-bit conversion time  $\geq 2.44 \mu\text{s}$  (up to 400 kSamples/s).
- Burst conversion mode for single or multiple inputs.

- Enabled by software but requires a hardware reset or a watchdog reset/interrupt to be disabled.
- Incorrect/Incomplete feed sequence causes reset/interrupt if enabled.
- Flag to indicate watchdog reset.
- Programmable 24-bit timer with internal prescaler.
- Selectable time period from  $(T_{cy(WDCLK)} \times 256 \times 4)$  to  $(T_{cy(WDCLK)} \times 2^{24} \times 4)$  in multiples of  $T_{cy(WDCLK)} \times 4$ .
- The Watchdog Clock (WDCLK) source can be selected from the Internal RC oscillator (IRC), the Watchdog oscillator, or the main clock. This gives a wide range of potential timing choices of Watchdog operation under different power reduction conditions. It also provides the ability to run the WDT from an entirely internal source that is not dependent on an external crystal and its associated components and wiring for increased reliability.

## 7.15 Windowed WatchDog Timer (LPC1100L and LPC1100XL series)

**Remark:** The windowed watchdog timer is available on the LPC1100L and LPC1100XL series only.

The purpose of the watchdog is to reset the controller if software fails to periodically service it within a programmable time window.

### 7.15.1 Features

- Internally resets chip if not periodically reloaded during the programmable time-out period.
- Optional windowed operation requires reload to occur between a minimum and maximum time period, both programmable.
- Optional warning interrupt can be generated at a programmable time prior to watchdog time-out.
- Enabled by software but requires a hardware reset or a watchdog reset/interrupt to be disabled.
- Incorrect feed sequence causes reset or interrupt if enabled.
- Flag to indicate watchdog reset.
- Programmable 24-bit timer with internal prescaler.
- Selectable time period from  $(T_{cy(WDCLK)} \times 256 \times 4)$  to  $(T_{cy(WDCLK)} \times 2^{24} \times 4)$  in multiples of  $T_{cy(WDCLK)} \times 4$ .
- The Watchdog Clock (WDCLK) source can be selected from the IRC or the dedicated watchdog oscillator (WDO). This gives a wide range of potential timing choices of watchdog operation under different power conditions.

## 7.16 Clocking and power control

### 7.16.1 Crystal oscillators

The LPC1110/11/12/13/14/15 include three independent oscillators. These are the system oscillator, the Internal RC oscillator (IRC), and the Watchdog oscillator. Each oscillator can be used for more than one purpose as required in a particular application.

Table 15. LPC111x/x02 Thermal resistance value (C/W):  $\pm 15\%$ 

HVQFN33		LQFP48	
$\theta_{ja}$		$\theta_{ja}$	
<b>JEDEC (4.5 in × 4 in)</b>		<b>JEDEC (4.5 in × 4 in)</b>	
0 m/s	40.8	0 m/s	83.3
1 m/s	33.1	1 m/s	74.9
2.5 m/s	28.7	2.5 m/s	69.4
<b>Single-layer (4.5 in × 3 in)</b>		<b>8-layer (4.5 in × 3 in)</b>	
0 m/s	85.2	0 m/s	116.3
1 m/s	62	1 m/s	96
2.5 m/s	53.5	2.5 m/s	87.5
$\theta_{jc}$	17.9	$\theta_{jc}$	28.3
$\theta_{jb}$	1.5	$\theta_{jb}$	35.5

**Table 16. Static characteristics (LPC1100, LPC1100L series) ...continued** $T_{amb} = -40\text{ }^{\circ}\text{C}$  to  $+85\text{ }^{\circ}\text{C}$ , unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ <sup>[1]</sup>	Max	Unit
I <sub>OL</sub>	LOW-level output current	V <sub>OL</sub> = 0.4 V; I <sup>2</sup> C-bus pins configured as Fast-mode Plus pins 2.5 V ≤ V <sub>DD</sub> ≤ 3.6 V	20	-	-	mA
		1.8 V ≤ V <sub>DD</sub> < 2.5 V	16	-	-	
I <sub>LI</sub>	input leakage current	V <sub>I</sub> = V <sub>DD</sub> <sup>[16]</sup>	-	2	4	μA
		V <sub>I</sub> = 5 V	-	10	22	μA
Oscillator pins						
V <sub>i(xtal)</sub>	crystal input voltage		−0.5	1.8	1.95	V
V <sub>o(xtal)</sub>	crystal output voltage		−0.5	1.8	1.95	V
Pin capacitance						
C <sub>io</sub>	input/output capacitance	pins configured for analog function	-	-	7.1	pF
		I <sup>2</sup> C-bus pins (PIO0_4 and PIO0_5)	-	-	2.5	pF
		pins configured as GPIO	-	-	2.8	pF

[1] Typical ratings are not guaranteed. The values listed are at room temperature (25 °C), nominal supply voltages.

[2]  $T_{amb} = 25\text{ }^{\circ}\text{C}$ .[3]  $I_{DD}$  measurements were performed with all pins configured as GPIO outputs driven LOW and pull-up resistors disabled.

[4] IRC enabled; system oscillator disabled; system PLL disabled.

[5] BOD disabled.

[6] All peripherals disabled in the SYSAHBCLKCTRL register. Peripheral clocks to UART and SPI0/1 disabled in system configuration block.

[7] IRC disabled; system oscillator enabled; system PLL enabled.

[8] All oscillators and analog blocks turned off in the PDSLEEPCFG register; PDSLEEPCFG = 0x0000 18FF.

[9] WAKEUP pin and RESET pin are pulled HIGH externally.

[10] System oscillator enabled; IRC disabled; system PLL disabled.

[11] Low-current mode PWR\_LOW\_CURRENT selected when running the set\_power routine in the power profiles.

[12] Including voltage on outputs in 3-state mode.

[13]  $V_{DD}$  supply voltage must be present.

[14] 3-state outputs go into 3-state mode in Deep power-down mode.

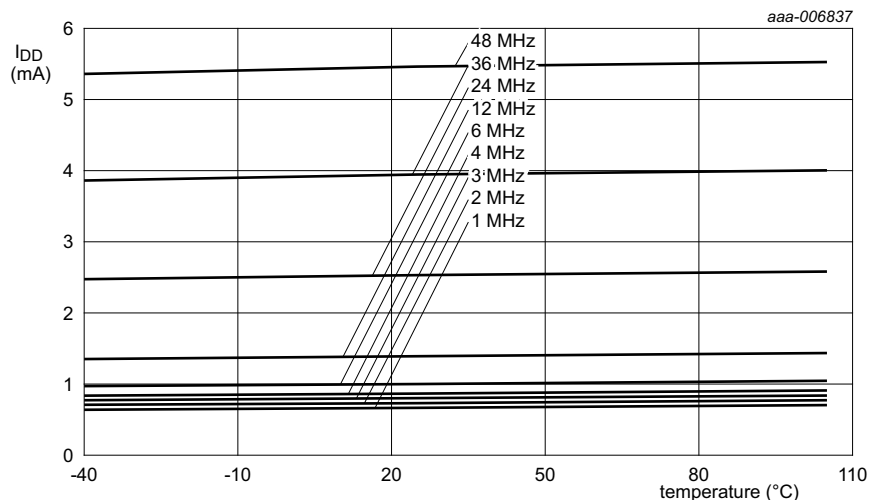
[15] Allowed as long as the current limit does not exceed the maximum current allowed by the device.

[16] To  $V_{SS}$ .

**Table 17. Static characteristics (LPC1100XL series) ...continued** $T_{amb} = -40\text{ }^{\circ}\text{C}$  to  $+105\text{ }^{\circ}\text{C}$ , unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ <sup>[1]</sup>	Max	Unit
<b>Oscillator pins</b>						
$V_{i(xtal)}$	crystal input voltage		-0.5	1.8	1.95	V
$V_{o(xtal)}$	crystal output voltage		-0.5	1.8	1.95	V
<b>Pin capacitance</b>						
$C_{io}$	input/output capacitance	pins configured for analog function	-	-	7.1	pF
		I <sup>2</sup> C-bus pins (PIO0_4 and PIO0_5)	-	-	2.5	pF
		pins configured as GPIO	-	-	2.8	pF

- [1] Typical ratings are not guaranteed. The values listed are at room temperature (25 °C), nominal supply voltages.
- [2] Low-current mode PWR\_LOW\_CURRENT selected when running the set\_power routine in the power profiles.
- [3]  $T_{amb} = 25\text{ }^{\circ}\text{C}$ .
- [4]  $I_{DD}$  measurements were performed with all pins configured as GPIO outputs driven LOW and pull-up resistors disabled.
- [5] System oscillator enabled; IRC disabled; system PLL disabled.
- [6] BOD disabled.
- [7] All peripherals disabled in the SYSAHBCLKCTRL register. Peripheral clocks to UART and SPI0/1 disabled in system configuration block.
- [8] IRC enabled; system oscillator disabled; system PLL disabled.
- [9] IRC disabled; system oscillator enabled; system PLL enabled.
- [10] All oscillators and analog blocks turned off in the PDSLEEPCFG register; PDSLEEPCFG = 0x0000 18FF.
- [11] 105 °C spec applies only to parts with the J designator (e.g. LPC1115JET48).
- [12] WAKEUP pin and RESET pin are pulled HIGH externally.
- [13] Including voltage on outputs in 3-state mode.
- [14]  $V_{DD}$  supply voltage must be present.
- [15] 3-state outputs go into 3-state mode in Deep power-down mode.
- [16] Allowed as long as the current limit does not exceed the maximum current allowed by the device.
- [17] To  $V_{SS}$ .



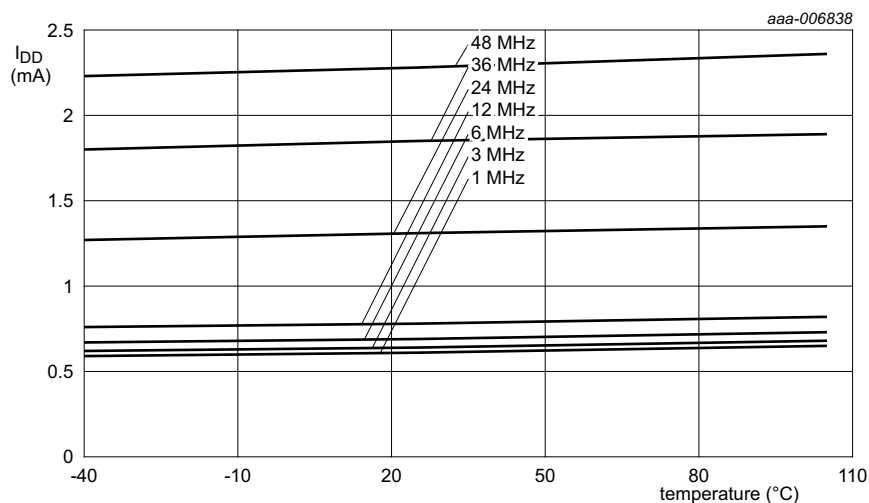
Conditions:  $V_{DD} = 3.3$  V; active mode entered executing code `while(1){}` from flash; all peripherals disabled in the SYSAHBCLKCTRL register (SYSAHBCLKCTRL = 0x1F); all peripheral clocks disabled; internal pull-up resistors disabled; BOD disabled; low-current mode.

1 MHz to 6 MHz: system oscillator enabled; PLL, IRC disabled.

12 MHz: IRC enabled; system oscillator, PLL disabled.

24 MHz to 48 MHz: IRC disabled; system oscillator, PLL enabled.

**Fig 29. Active mode: Typical supply current  $I_{DD}$  versus temperature for different system clock frequencies (for LPC111xXL)**



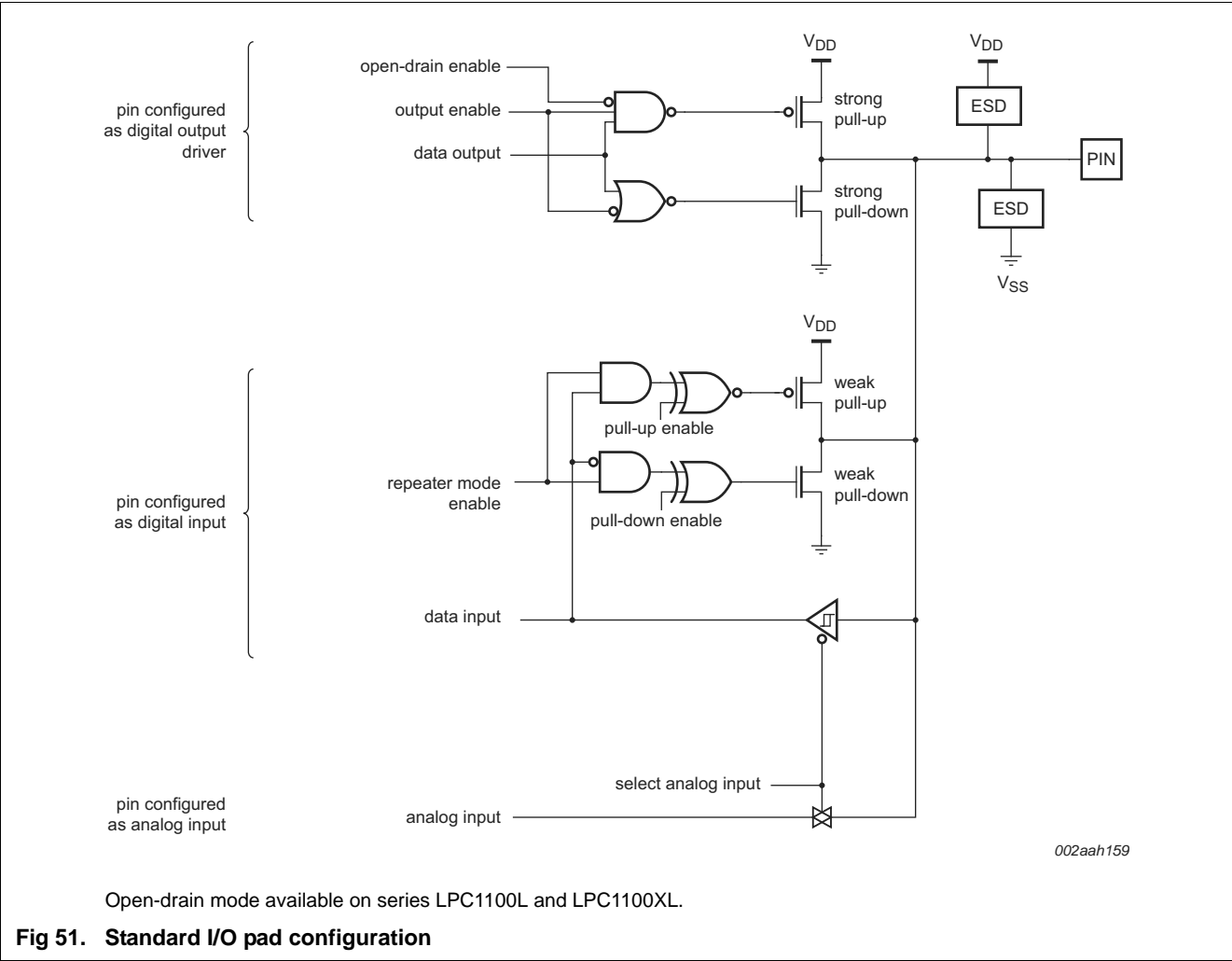
Conditions:  $V_{DD} = 3.3$  V; sleep mode entered from flash; all peripherals disabled in the SYSAHBCLKCTRL register (SYSAHBCLKCTRL = 0x1F); all peripheral clocks disabled; internal pull-up resistors disabled; BOD disabled; low-current mode.

1 MHz to 6 MHz: system oscillator enabled; PLL, IRC disabled.

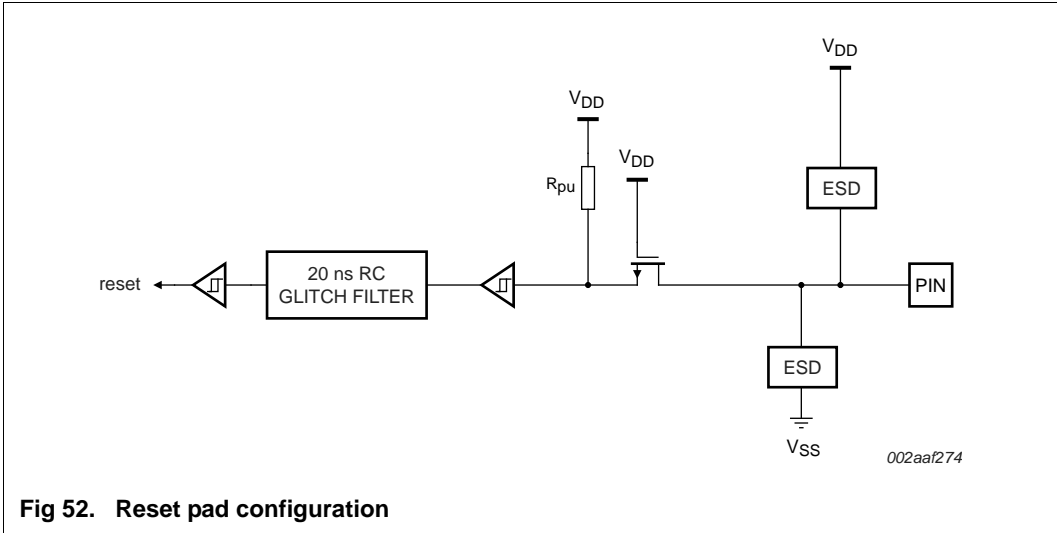
12 MHz: IRC enabled; system oscillator, PLL disabled.

24 MHz to 48 MHz: IRC disabled; system oscillator, PLL enabled.

**Fig 30. Sleep mode: Typical supply current  $I_{DD}$  versus temperature for different system clock frequencies (for LPC111xXL)**



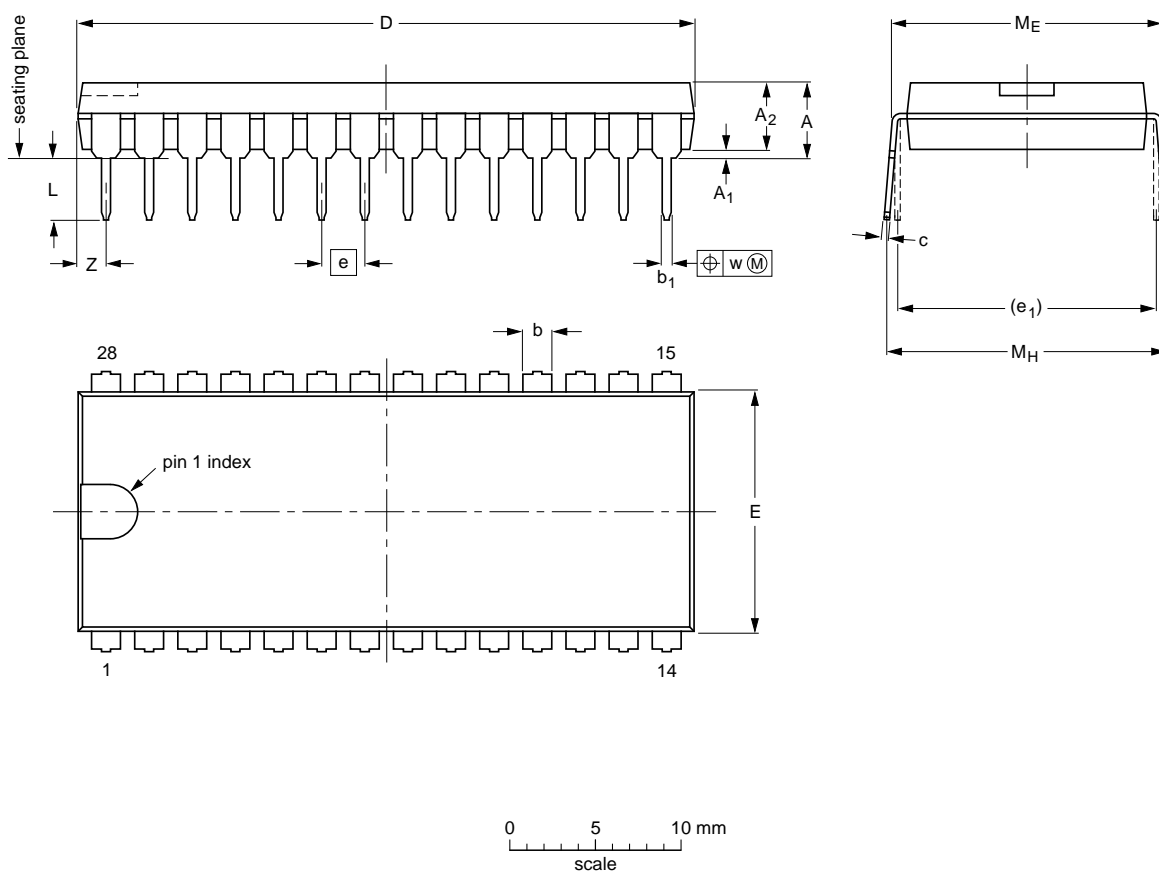
12.6 Reset pad configuration





DIP28: plastic dual in-line package; 28 leads (600 mil)

SOT117-1



DIMENSIONS (mm dimensions are derived from the original inch dimensions)

UNIT	A max.	A <sub>1</sub> min.	A <sub>2</sub> max.	b	b <sub>1</sub>	c	D <sup>(1)</sup>	E <sup>(1)</sup>	e	e <sub>1</sub>	L	M <sub>E</sub>	M <sub>H</sub>	w	Z <sup>(1)</sup> max.
mm	5.1	0.51	4	1.7 1.3	0.53 0.38	0.32 0.23	36 35	14.1 13.7	2.54	15.24	3.9 3.4	15.80 15.24	17.15 15.90	0.25	1.7
inches	0.2	0.02	0.16	0.066 0.051	0.020 0.014	0.013 0.009	1.41 1.34	0.56 0.54	0.1	0.6	0.15 0.13	0.62 0.60	0.68 0.63	0.01	0.067

**Note**

1. Plastic or metal protrusions of 0.25 mm (0.01 inch) maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT117-1	051G05	MO-015	SC-510-28			99-12-27 03-02-13

Fig 57. Package outline SOT117-1 (DIP28)

HVQFN33: plastic thermal enhanced very thin quad flat package; no leads;  
32 terminals; body 5 x 5 x 0.85 mm

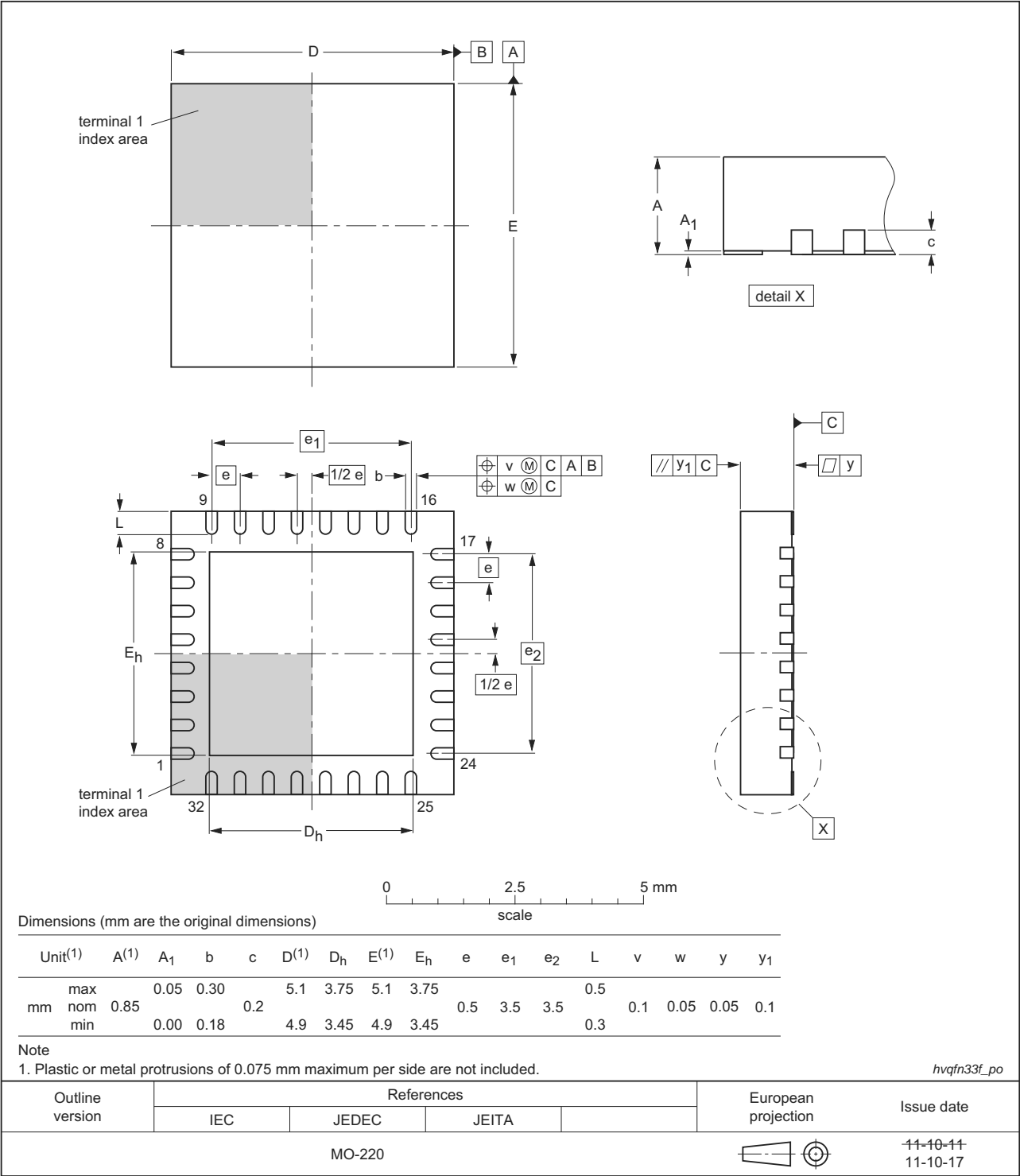


Fig 58. Package outline (HVQFN33 5x5)

TFBGA48: plastic thin fine-pitch ball grid array package; 48 balls; body 4.5 x 4.5 x 0.7 mm

SOT1155-2

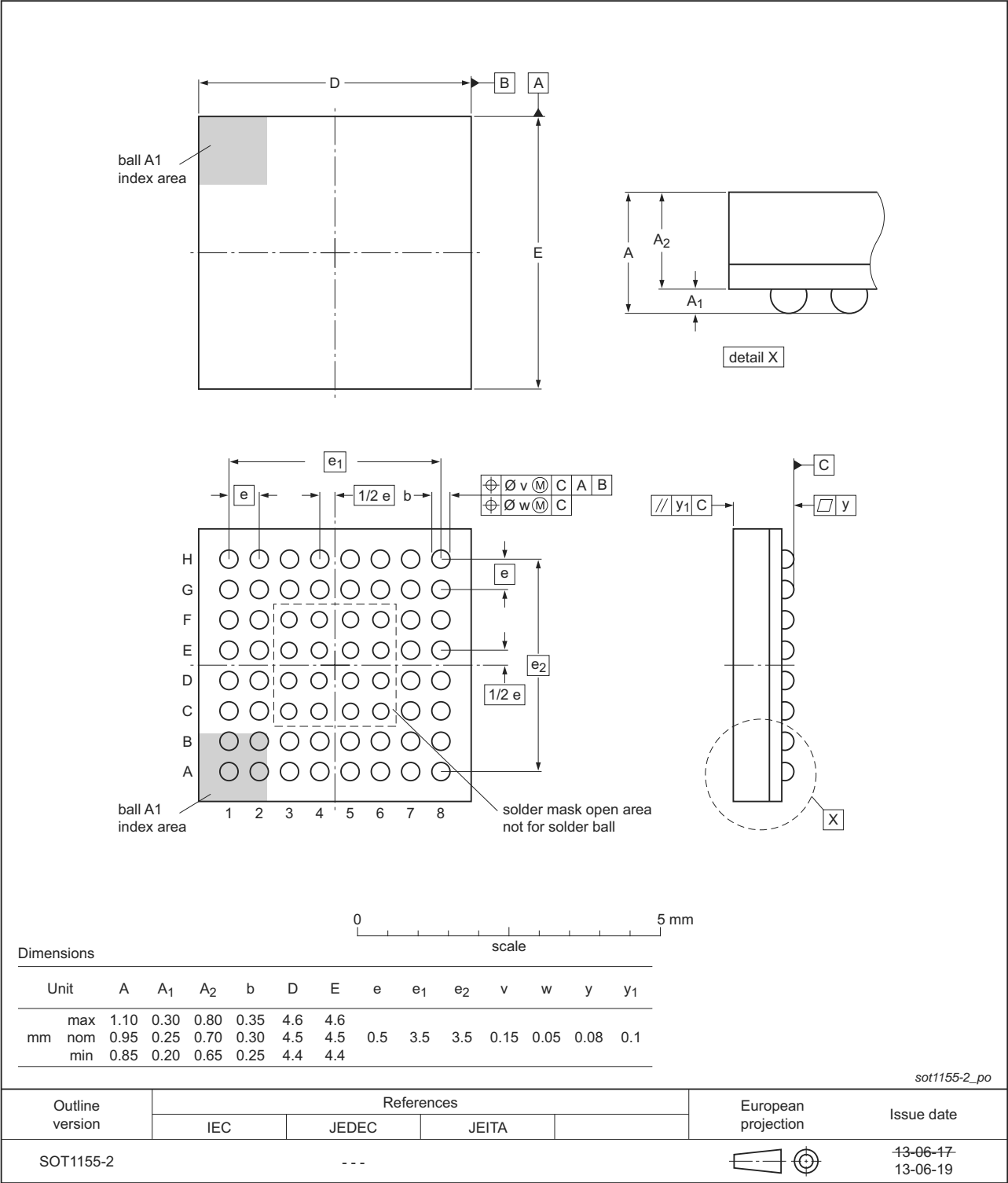


Fig 62. Package outline TFBGA48 (SOT1155-2)

## 17. Revision history

Table 34. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
LPC111X v.9.2	20140326	Product data sheet	-	LPC111X v.9.1
Modifications:	<ul style="list-style-type: none"> <li>Pin description tables for RESET/PIO0_0 updated: In deep power-down mode, this pin must be pulled HIGH externally. The RESET pin can be left unconnected or be used as a GPIO pin if an external RESET function is not needed. See <a href="#">Section 6.2</a>.</li> <li>Pin description notes relating to open-drain I2C-bus pins updated for clarity in <a href="#">Section 6.2</a>.</li> <li>Pin description of the WAKEUP pin updated for clarity. See <a href="#">Section 6.2</a>.</li> <li>Parts added: LPC1114JHI33/303, LPC1111JHN33/103, LPC1112JHN33/203, LPC1113JHN33/203, LPC1114JHN33/303, LPC1114JBD48/333, LPC1112FHI33/102, LPC1114JBD48/303, LPC1114JBD48/323, LPC1113JBD48/303, LPC1113JHN33/303, LPC1112JHN33/103, LPC1111JHN33/203, LPC1114JHN33/203.</li> </ul>			
LPC111X v.9.1	20131213	Product data sheet	-	LPC111X v.9
Modifications:	<ul style="list-style-type: none"> <li>Table 17 "Static characteristics (LPC1100XL series)": <ul style="list-style-type: none"> <li>Added I<sub>DD</sub> max spec for Deep-sleep and Deep power-down modes @ 25 °C and 105 °C.</li> <li>Added Table note 11 "105 °C spec applies only to the LPC1112JHI33, LPC1114JHN33, LPC1115JBD48, and LPC1115JET48 parts."</li> <li>Updated Table note 12 "WAKEUP pin and RESET pin are pulled HIGH externally."</li> </ul> </li> <li>Table 16 "Static characteristics (LPC1100, LPC1100L series)": <ul style="list-style-type: none"> <li>Updated Table note 9 "WAKEUP pin and RESET pin are pulled HIGH externally."</li> </ul> </li> </ul>			
LPC111X v.9	20131029	Product data sheet	-	LPC111X v.8.2
Modifications:	<ul style="list-style-type: none"> <li>Added LPC1112JHI33/203, LPC1114JHN33/333, LPC1115JBD48/303, and LPC1115JET48/303 parts.</li> <li>Removed t<sub>clk(H)</sub> and t<sub>clk(L)</sub> from Figure 47 "SPI master timing in SPI mode" and Figure 48 "SPI slave timing in SPI mode"; spec not characterized.</li> <li>Table 22 "Power-up characteristics[1]": Added table note "Does not apply to LPC1100XL series".</li> </ul>			
LPC111X v.8.2	20130805	Product data sheet	-	LPC111X v.8.1
Modifications:	<ul style="list-style-type: none"> <li>Added LPC1115FET48/303.</li> </ul>			
LPC111X v.8.1	20130524	Product data sheet	-	LPC111X v.8
Modifications:	<ul style="list-style-type: none"> <li>Table 4 thru Table 11: Added "5 V tolerant pad" to RESET/PIO0_0 table note.</li> <li>Added Section 9 "Thermal characteristics".</li> <li>SRAM size corrected for part LPC1112FHN24/202 (4 kB). See Table 2.</li> </ul>			
LPC111X v.8	20130220	Product data sheet	-	LPC111X v.7.5
Modifications:	<ul style="list-style-type: none"> <li>Table 16 "Static characteristics" added Pin capacitance section.</li> <li>Default pin state corrected for pins PIO0_4 and PIO0_5 (I; IA) in Table 11 "LPC1100XL series: LPC1111/12/13/14 pin description table (HVQFN33 package)".</li> <li>Table 12 "Limiting values" expanded for clarity.</li> <li>Table 19 "Power consumption at very low frequencies using the watchdog oscillator" added.</li> <li>Added Section 12.2 "Use of ADC input trigger signals".</li> <li>Added Section 12.8 "ADC effective input impedance".</li> </ul>			
LPC111X v.7.5	20121002	Product data sheet	-	LPC111X v.7.4

## 20. Contents

<b>1</b>	<b>General description</b> . . . . .	<b>1</b>	7.16.5.1	Power profiles (LPC1100L and LPC1100XL series only) . . . . .	54
<b>2</b>	<b>Features and benefits</b> . . . . .	<b>1</b>	7.16.5.2	Sleep mode . . . . .	55
<b>3</b>	<b>Applications</b> . . . . .	<b>3</b>	7.16.5.3	Deep-sleep mode . . . . .	55
<b>4</b>	<b>Ordering information</b> . . . . .	<b>3</b>	7.16.5.4	Deep power-down mode . . . . .	55
4.1	Ordering options . . . . .	6	7.17	System control . . . . .	55
<b>5</b>	<b>Block diagram</b> . . . . .	<b>9</b>	7.17.1	Start logic . . . . .	55
<b>6</b>	<b>Pinning information</b> . . . . .	<b>11</b>	7.17.2	Reset . . . . .	56
6.1	Pinning . . . . .	11	7.17.3	Brownout detection . . . . .	56
6.2	Pin description . . . . .	19	7.17.4	Code security (Code Read Protection - CRP) . . . . .	56
<b>7</b>	<b>Functional description</b> . . . . .	<b>45</b>	7.17.5	APB interface . . . . .	57
7.1	ARM Cortex-M0 processor . . . . .	45	7.17.6	AHBLite . . . . .	57
7.2	On-chip flash program memory . . . . .	45	7.17.7	External interrupt inputs . . . . .	57
7.3	On-chip SRAM . . . . .	45	7.18	Emulation and debugging . . . . .	57
7.4	Memory map . . . . .	45	<b>8</b>	<b>Limiting values</b> . . . . .	<b>58</b>
7.5	Nested Vectored Interrupt Controller (NVIC) . . . . .	47	<b>9</b>	<b>Thermal characteristics</b> . . . . .	<b>59</b>
7.5.1	Features . . . . .	47	<b>10</b>	<b>Static characteristics</b> . . . . .	<b>61</b>
7.5.2	Interrupt sources . . . . .	48	10.1	LPC1100, LPC1100L series . . . . .	61
7.6	IOCONFIG block . . . . .	48	10.2	LPC1100XL series . . . . .	65
7.7	Fast general purpose parallel I/O . . . . .	48	10.3	ADC static characteristics . . . . .	69
7.7.1	Features . . . . .	48	10.4	BOD static characteristics . . . . .	71
7.8	UART . . . . .	49	10.5	Power consumption LPC1100 series (LPC111x/101/201/301) . . . . .	72
7.8.1	Features . . . . .	49	10.6	Power consumption LPC1100L series (LPC111x/002/102/202/302) . . . . .	75
7.9	SPI serial I/O controller . . . . .	49	10.7	Power consumption LPC1100XL series (LPC111x/103/203/303/323/333) . . . . .	78
7.9.1	Features . . . . .	49	10.8	CoreMark data . . . . .	82
7.10	I <sup>2</sup> C-bus serial I/O controller . . . . .	50	10.9	Peripheral power consumption . . . . .	84
7.10.1	Features . . . . .	50	10.10	Electrical pin characteristics . . . . .	85
7.11	10-bit ADC . . . . .	50	<b>11</b>	<b>Dynamic characteristics</b> . . . . .	<b>88</b>
7.11.1	Features . . . . .	50	11.1	Power-up ramp conditions . . . . .	88
7.12	General purpose external event counter/timers . . . . .	51	11.2	Flash memory . . . . .	88
7.12.1	Features . . . . .	51	11.3	External clock . . . . .	89
7.13	System tick timer . . . . .	51	11.4	Internal oscillators . . . . .	90
7.14	Watchdog timer (LPC1100 series, LPC111x/101/201/301) . . . . .	51	11.5	I/O pins . . . . .	92
7.14.1	Features . . . . .	51	11.6	I <sup>2</sup> C-bus . . . . .	93
7.15	Windowed WatchDog Timer (LPC1100L and LPC1100XL series) . . . . .	52	11.7	SPI interfaces . . . . .	94
7.15.1	Features . . . . .	52	<b>12</b>	<b>Application information</b> . . . . .	<b>97</b>
7.16	Clocking and power control . . . . .	52	12.1	ADC usage notes . . . . .	97
7.16.1	Crystal oscillators . . . . .	52	12.2	Use of ADC input trigger signals . . . . .	97
7.16.1.1	Internal RC oscillator . . . . .	53	12.3	XTAL input . . . . .	97
7.16.1.2	System oscillator . . . . .	53	12.4	XTAL Printed Circuit Board (PCB) layout guidelines . . . . .	99
7.16.1.3	Watchdog oscillator . . . . .	54	12.5	Standard I/O pad configuration . . . . .	99
7.16.2	System PLL . . . . .	54	12.6	Reset pad configuration . . . . .	100
7.16.3	Clock output . . . . .	54	12.7	ElectroMagnetic Compatibility (EMC) . . . . .	101
7.16.4	Wake-up process . . . . .	54			
7.16.5	Power control . . . . .	54			

continued &gt;&gt;